



# PMEG100T050ELPE-Q

100 V, 5 A low leakage current Trench Schottky barrier rectifier

19 July 2024

Product data sheet

## 1. General description

Trench Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Low forward voltage
- Low  $Q_{rr}$  and low  $I_{RM}$
- Low leakage current
- High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- High efficiency DC-to-DC conversion
- Automotive LED lighting
- Switch mode power supply
- Freewheeling application
- Reverse polarity protection
- OR-ing

## 4. Quick reference data

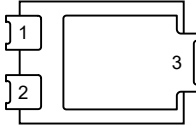
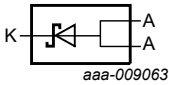
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 163$ °C		-	-	5	A
$V_R$	reverse voltage	$T_j = 25$ °C		-	-	100	V
$V_F$	forward voltage	$I_F = 5$ A; pulsed; $T_j = 25$ °C	[1]	-	750	810	mV
$I_R$	reverse current	$V_R = 100$ V; pulsed; $T_j = 25$ °C	[1]	-	0.4	2.5	$\mu$ A
		$V_R = 100$ V; pulsed; $T_j = 125$ °C	[1]	-	0.6	3	mA

[1] Very short pulse, in order to maintain a stable junction temperature.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	 CFP15B (SOT1289B)	 aaa-009063
2	A	anode		
3	K	cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">PMEG100T050ELPE-Q</a>	CFP15B	plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	<a href="#">SOT1289B</a>

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG100T050ELPE-Q	100T L05E

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	$T_j = 25\text{ }^{\circ}\text{C}$		-	100	V
$I_F$	forward current	$\delta = 1; T_{sp} \leq 159\text{ }^{\circ}\text{C}$		-	7	A
$I_{F(AV)}$	average forward current	$\delta = 0.5; f = 20\text{ kHz; square wave; } T_{sp} \leq 163\text{ }^{\circ}\text{C}$		-	5	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 8.3\text{ ms; half sine wave; } T_{j(init)} = 25\text{ }^{\circ}\text{C}$		-	100	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ }^{\circ}\text{C}$	[1]	-	1.66	W
			[2]	-	2.15	W
$T_j$	junction temperature			-	175	$^{\circ}\text{C}$
$T_{amb}$	ambient temperature			-55	175	$^{\circ}\text{C}$
$T_{stg}$	storage temperature			-65	175	$^{\circ}\text{C}$

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	90	K/W
			[1] [3]	-	-	70	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.

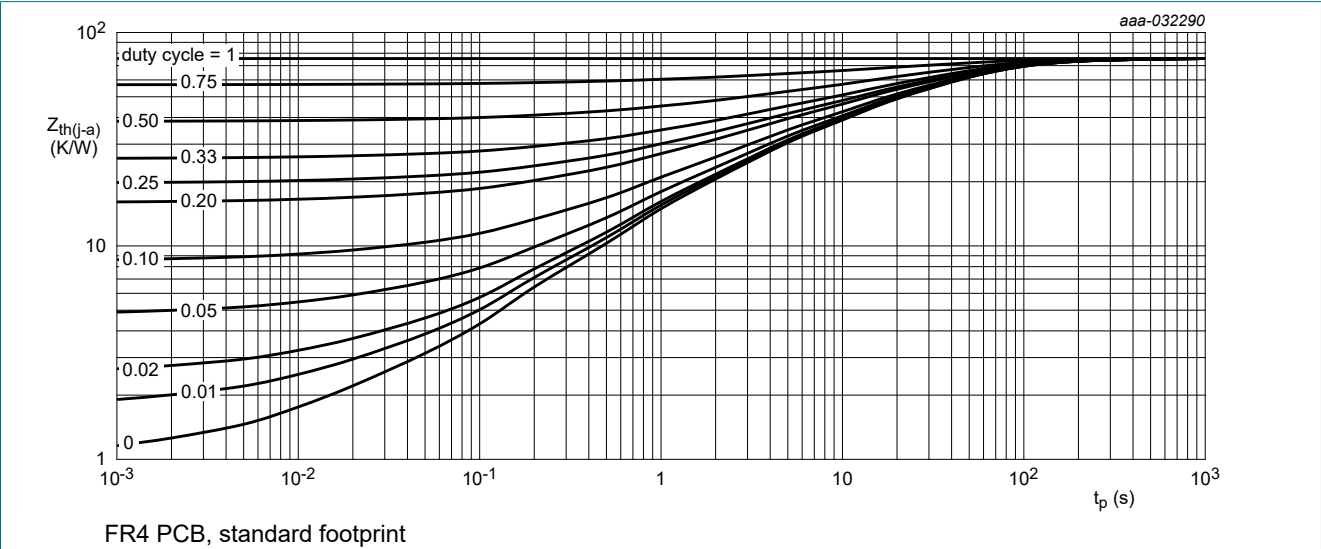


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

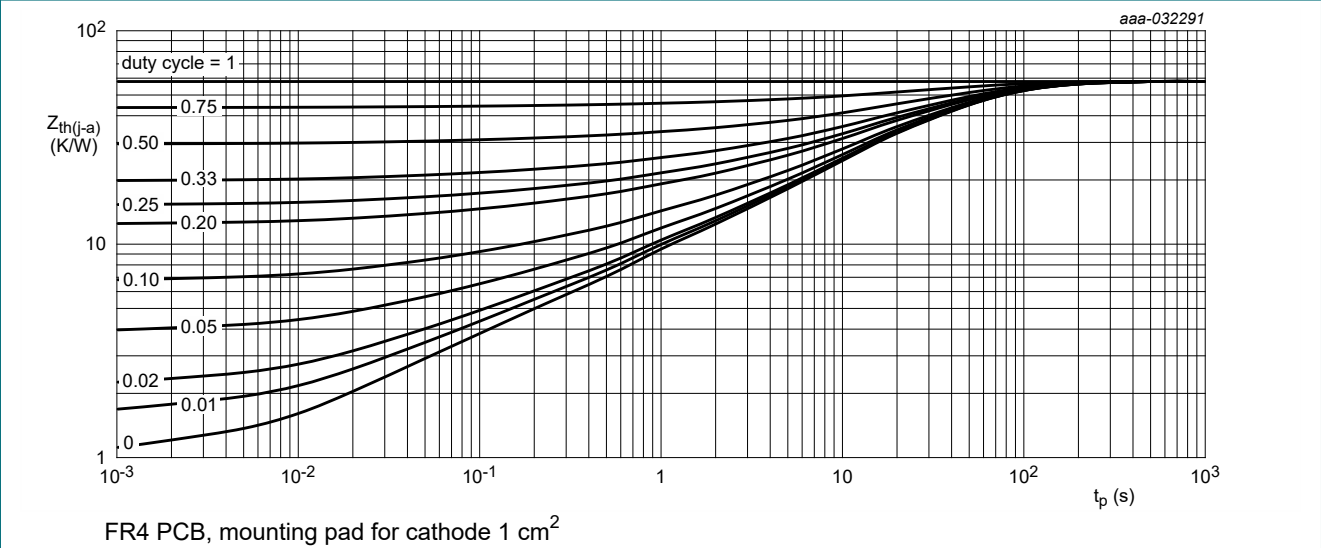


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 1\text{ mA}$ ; $T_j = 25\text{ °C}$	[1]	100	-	-	V
$V_F$	forward voltage	$I_F = 0.5\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	460	560	mV
		$I_F = 1\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	510	580	mV
		$I_F = 2\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	580	650	mV
		$I_F = 3\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	650	710	mV
		$I_F = 5\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	750	810	mV
		$I_F = 5\text{ A}$ ; pulsed; $T_j = -40\text{ °C}$	[1]	-	755	820	mV
		$I_F = 5\text{ A}$ ; pulsed; $T_j = 125\text{ °C}$	[1]	-	620	690	mV
		$I_F = 5\text{ A}$ ; pulsed; $T_j = 150\text{ °C}$	[1]	-	580	660	mV
$I_R$	reverse current	$V_R = 60\text{ V}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	0.15	0.63	μA
		$V_R = 100\text{ V}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	0.4	2.5	μA
		$V_R = 100\text{ V}$ ; pulsed; $T_j = 125\text{ °C}$	[1]	-	0.6	3	mA
		$V_R = 100\text{ V}$ ; pulsed; $T_j = 150\text{ °C}$	[1]	-	2.3	12	mA
$C_d$	diode capacitance	$V_R = 1\text{ V}$ ; $f = 1\text{ MHz}$ ; $T_j = 25\text{ °C}$		-	410	-	pF
		$V_R = 10\text{ V}$ ; $f = 1\text{ MHz}$ ; $T_j = 25\text{ °C}$		-	120	-	pF
$t_{rr}$	reverse recovery time step recovery	$I_F = 0.5\text{ A}$ ; $I_R = 0.5\text{ A}$ ; $I_{R(meas)} = 0.1\text{ A}$ ; $T_j = 25\text{ °C}$		-	12	-	ns
	reverse recovery time ramp recovery	$di_F/dt = 200\text{ A/μs}$ ; $I_F = 6\text{ A}$ ; $V_R = 26\text{ V}$ ; $T_j = 25\text{ °C}$		-	12	-	ns
$I_{RM}$	peak reverse recovery current			-	1.3	-	A
$Q_{rr}$	reverse recovery charge			-	9.5	-	nC
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5\text{ A}$ ; $di_F/dt = 20\text{ A/μs}$ ; $T_j = 25\text{ °C}$		-	460	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.

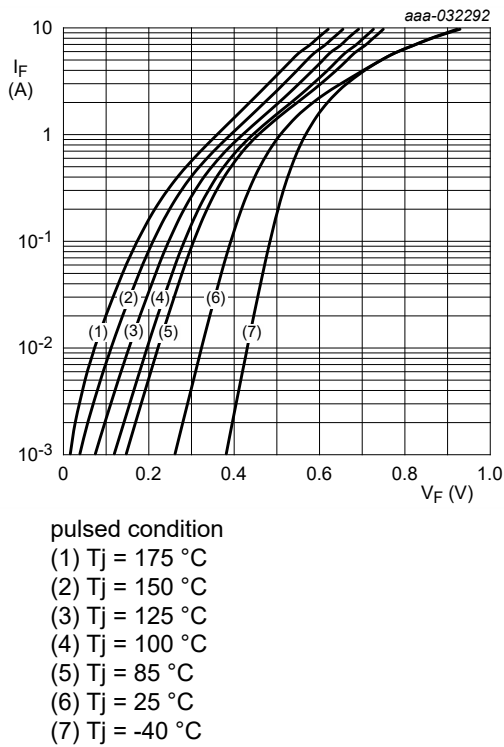


Fig. 3. Forward current as a function of forward voltage; typical values

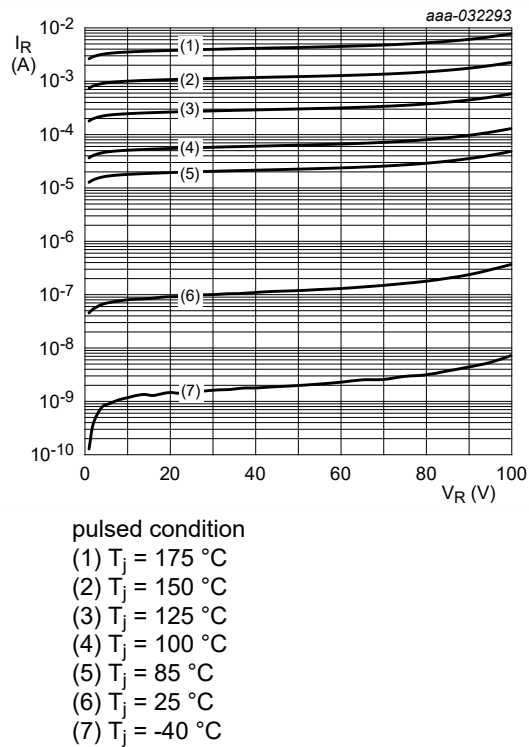


Fig. 4. Reverse current as a function of reverse voltage; typical values

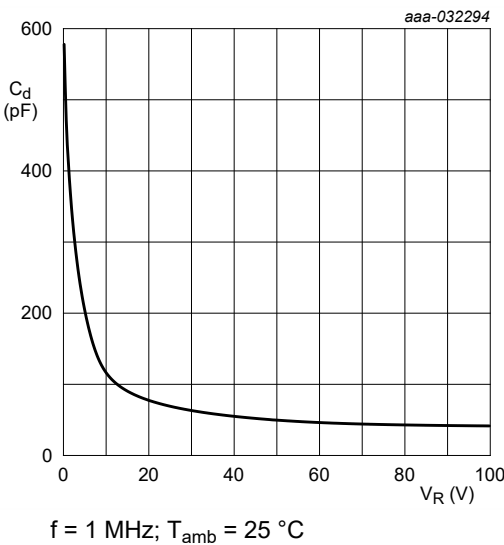


Fig. 5. Diode capacitance as a function of reverse voltage; typical values

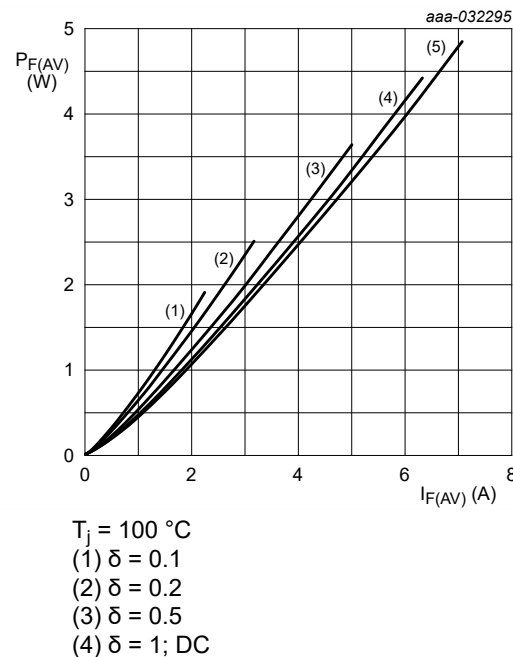


Fig. 6. Average forward power dissipation as a function of average forward current; typical values

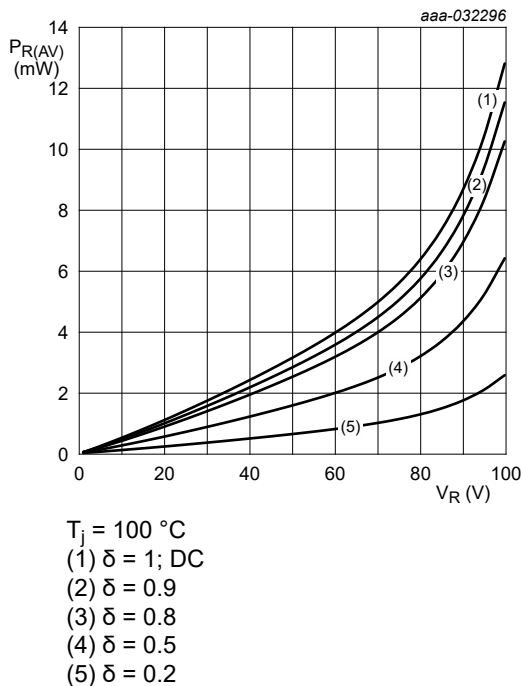


Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values

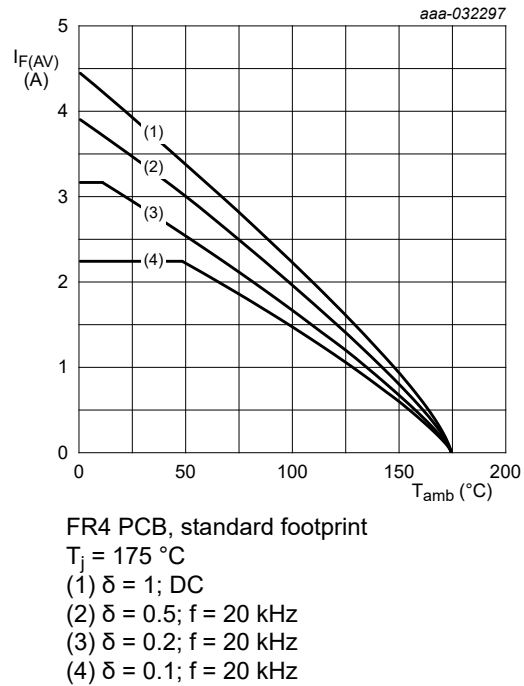


Fig. 8. Average forward current as a function of ambient temperature; typical values

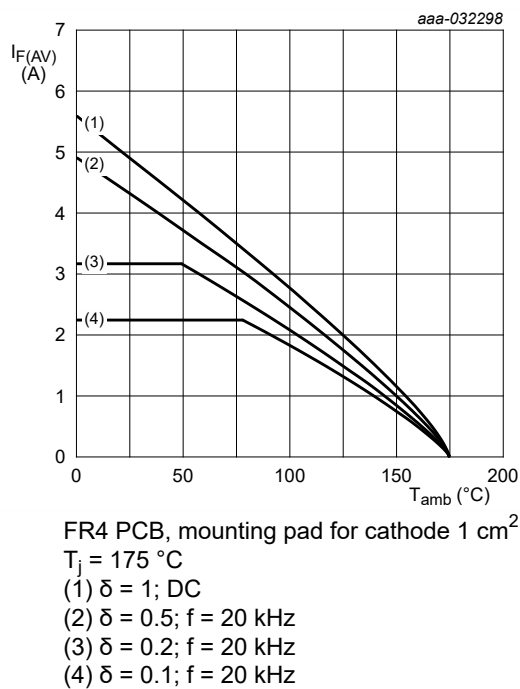


Fig. 9. Average forward current as a function of ambient temperature; typical values

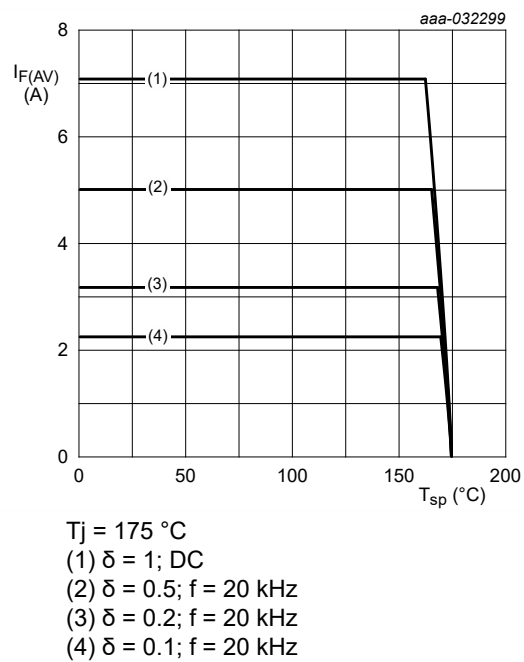


Fig. 10. Average forward current as a function of solder point temperature; typical values

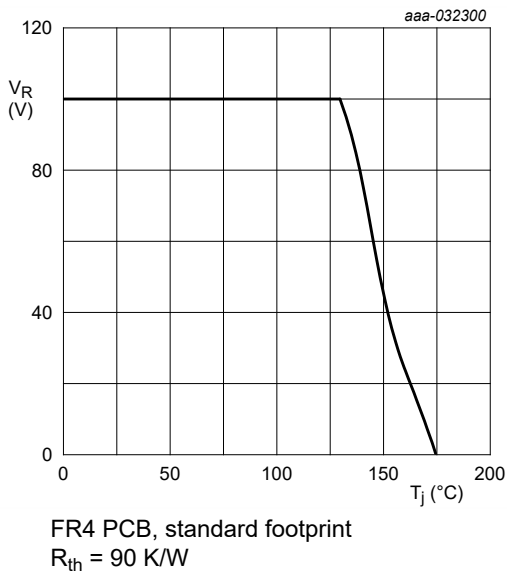


Fig. 11. Derated maximum reverse voltage as a function of junction temperature; typical values

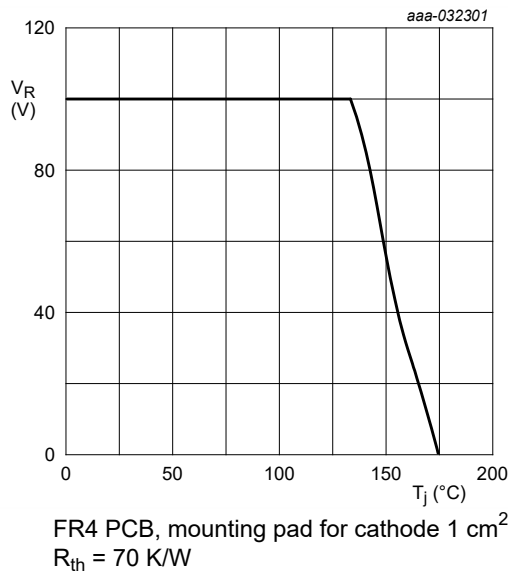


Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values

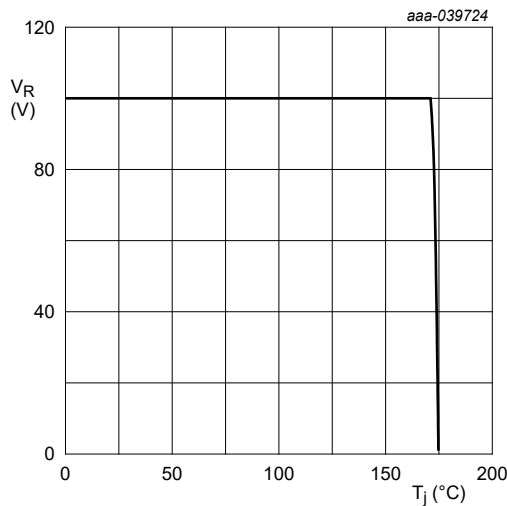


Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

11. Test information

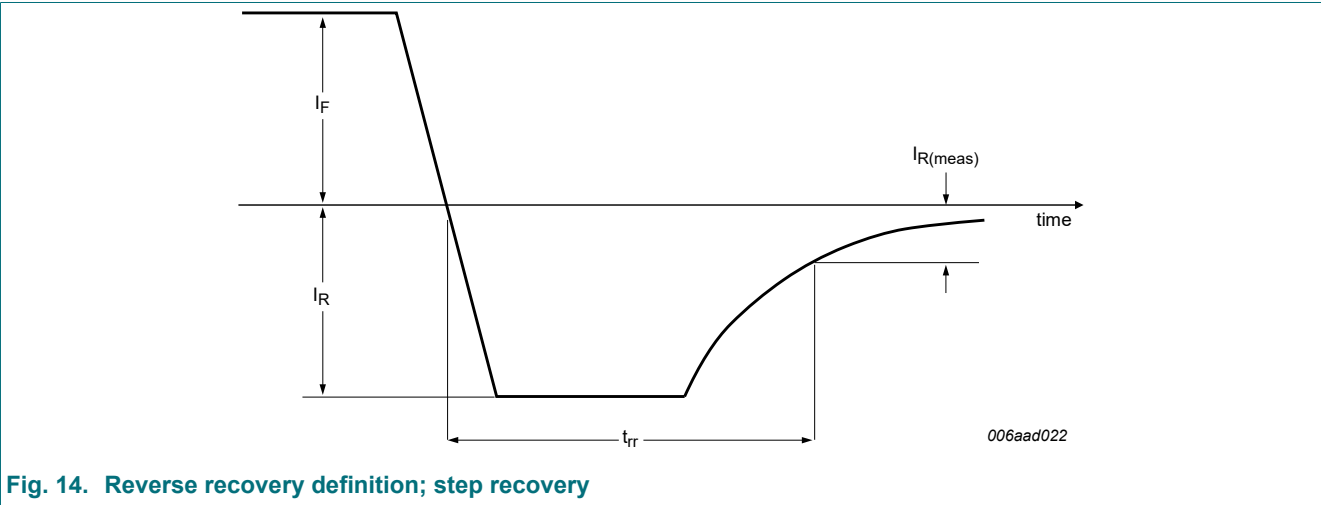


Fig. 14. Reverse recovery definition; step recovery

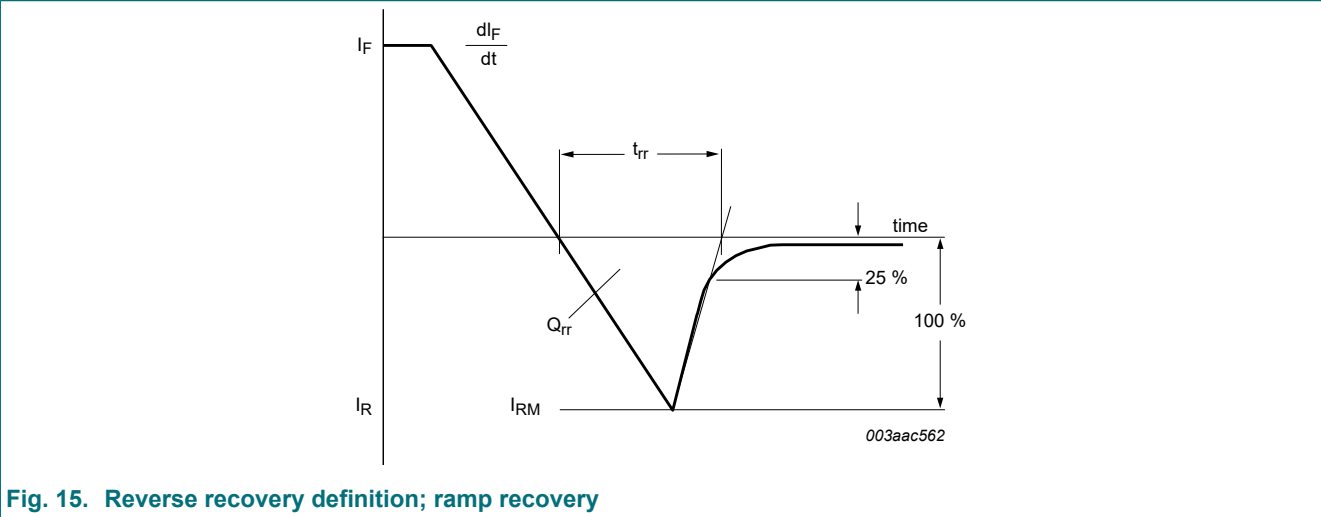


Fig. 15. Reverse recovery definition; ramp recovery

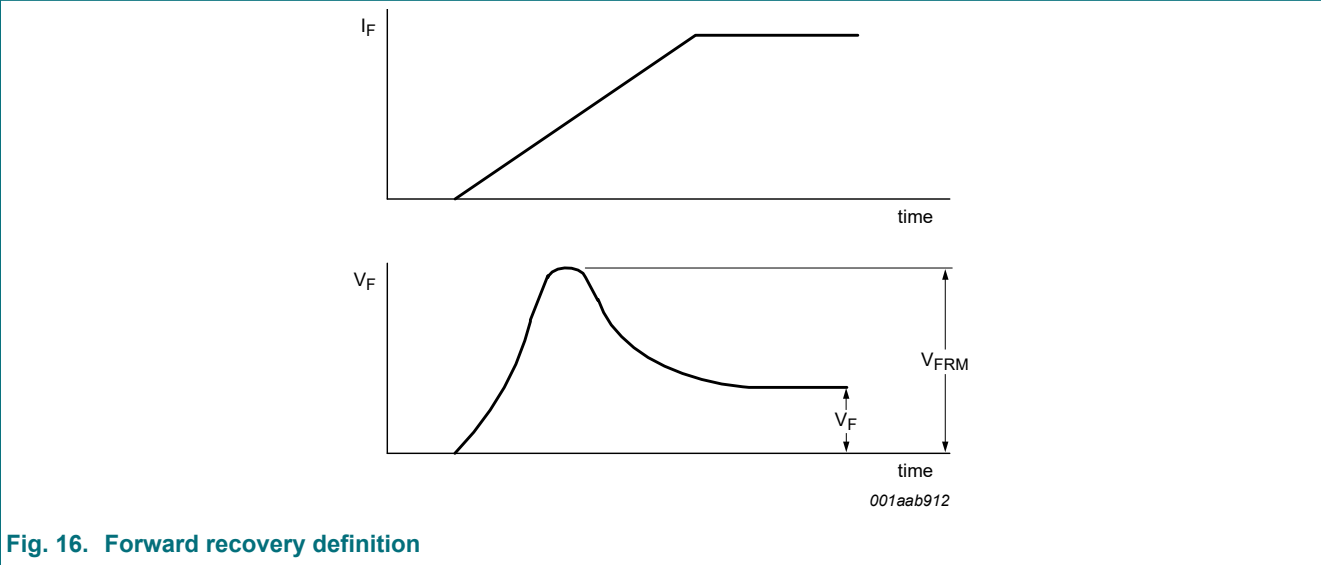


Fig. 16. Forward recovery definition



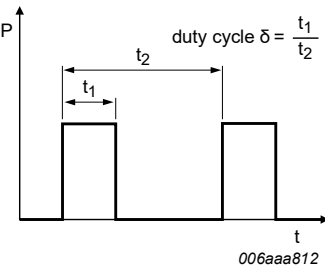


Fig. 17. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

$I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$

with  $I_{RMS}$  defined as RMS current.

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

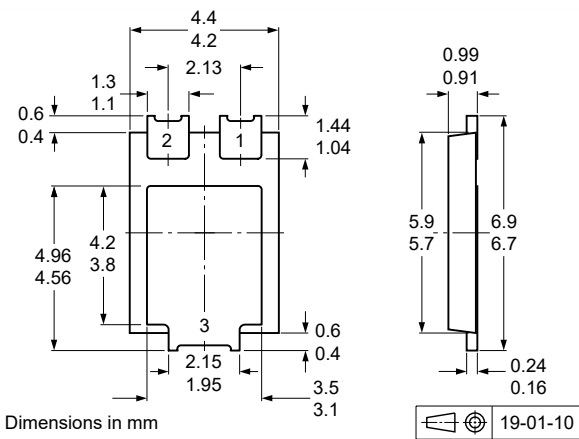
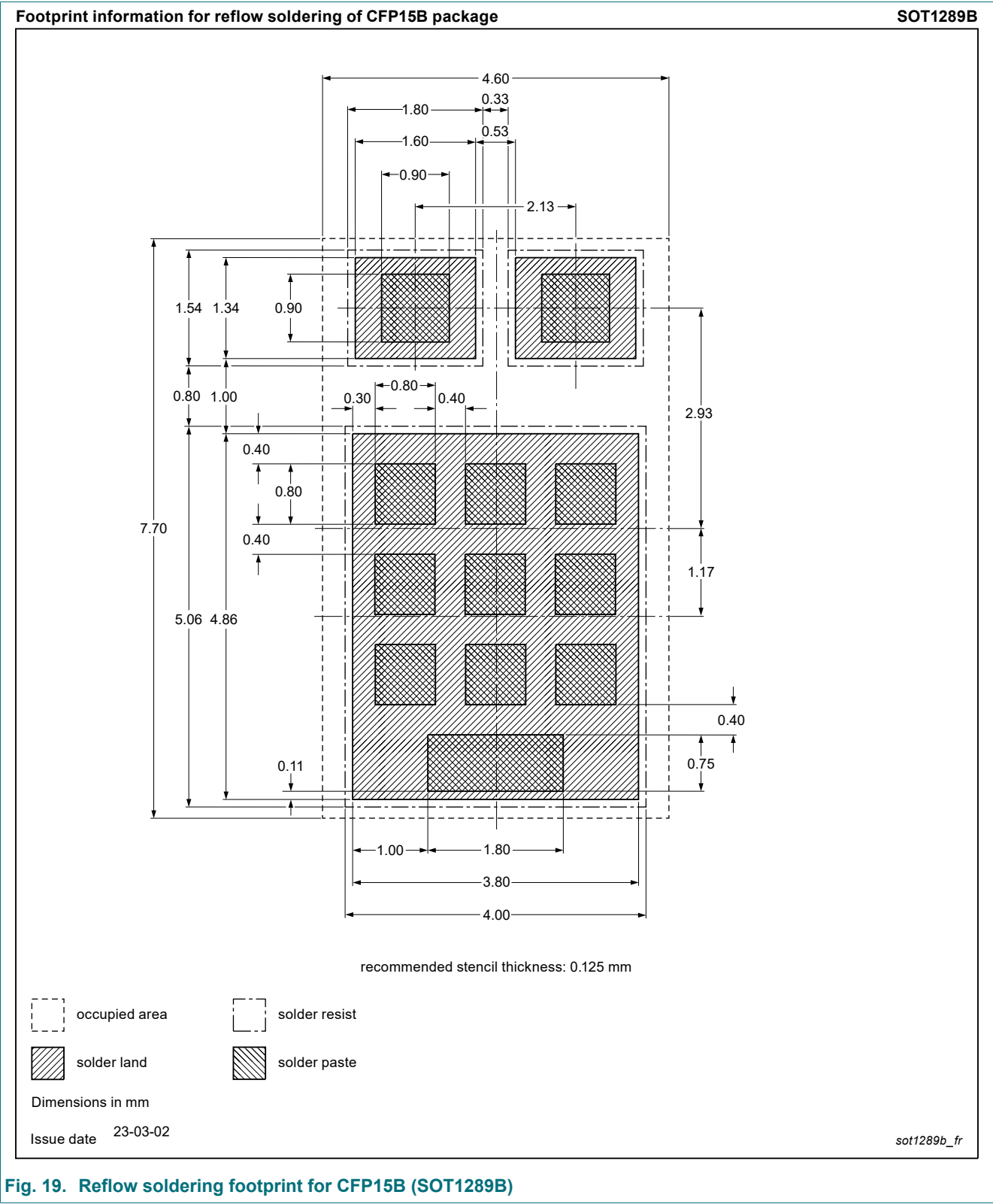


Fig. 18. Package outline CFP15B (SOT1289B)

13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG100T050ELPE-Q v.4	20240719	Product data sheet	-	PMEG100T050ELPE-Q v.3
Modifications:	<ul style="list-style-type: none"><li>Thermal characteristics: <math>R_{th(j-sp)}</math> value changed</li><li>Characteristics: <math>I_{RM}</math> and <math>Q_{rr}</math> conditions changed</li><li>Characteristics: Fig 7 and Fig 13 changed</li></ul>			
PMEG100T050ELPE-Q v.3	20240715	Product data sheet	-	PMEG100T050ELPE-Q v.2
PMEG100T050ELPE-Q v.2	20210510	Product data sheet	-	PMEG100T050ELPE-Q v.1
PMEG100T050ELPE-Q v.1	20210217	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Contents

1. General description..... 1

2. Features and benefits..... 1

3. Applications..... 1

4. Quick reference data..... 1

5. Pinning information.....2

6. Ordering information.....2

7. Marking.....2

8. Limiting values..... 2

9. Thermal characteristics..... 3

10. Characteristics..... 4

11. Test information..... 8

12. Package outline..... 9

13. Soldering..... 10

14. Revision history..... 11

15. Legal information.....12

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Date of release: 19 July 2024

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